Silicon NPN Epitaxial

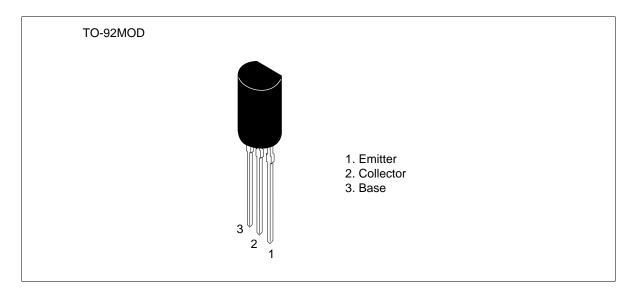
HITACHI

ADE-208-1159 (Z) 1st. Edition Mar. 2001

Application

Low frequency high voltage amplifier

Outline





Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

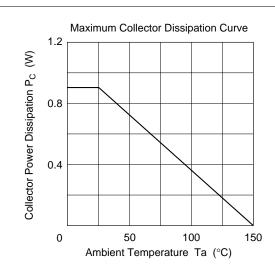
Item	Symbol	2SA1868	2SA1869	Unit
Collector to base voltage	V_{CBO}	160	200	V
Collector to emitter voltage	V _{CEO}	160	200	V
Emitter to base voltage	V_{EBO}	5	5	V
Collector current	I _c	100	100	mA
Collector power dissipation	P _c	0.9	0.9	W
Junction temperature	Tj	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	°C

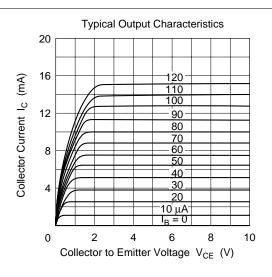
Electrical Characteristics ($Ta = 25^{\circ}C$)

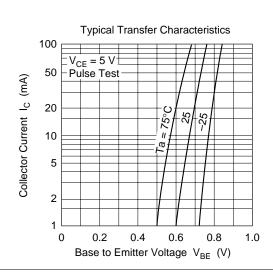
Item		Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	2SD1868	$V_{(BR)CBO}$	160	_	_	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
	2SD1869	_	200				
Collector to emitter breakdown voltage	2SD1868	$V_{(BR)CEO}$	160	_	_	V	I_{C} = 1 mA, R_{BE} = ∞
	2SD1869		200				
Emitter to base brea	akdown	$V_{(BR)EBO}$	5	_	_	V	$I_{E} = 10 \mu A, I_{C} = 0$
Collector cutoff current	2SD1868	I _{CBO}	_	_	10	μΑ	$V_{CB} = 140 \text{ V}, I_{E} = 0$
	2SD1869	=					$V_{CB} = 160 \text{ V}, I_{E} = 0$
DC current transfer ratio		h _{FE1} *1	60	_	320		$V_{CE} = 5 \text{ V}, I_{C} = 10 \text{ mA}$
		h _{FE2}	30	_	_		$V_{CE} = 5 \text{ V}, I_{C} = 1 \text{ mA}$
Base to emitter voltage		V _{BE}		_	1.5	V	$V_{CE} = 5 \text{ V}, I_{C} = 10 \text{ mA}$
Collector to emitter saturation voltage		$V_{\text{CE(sat)}}$	_	_	2	V	$I_C = 30 \text{ mA}, I_B = 3 \text{ mA}$
Gain bandwidth product		f _T	_	140	_	MHz	$V_{CE} = 5 \text{ V}, I_{C} = 10 \text{ mA}$
Collector output capacitance		C _{ob}	_	3.8	_	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$

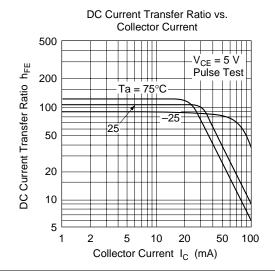
Note: 1. The 2SD1868 and 2SD1869 are grouped by h_{FE1} as follows.

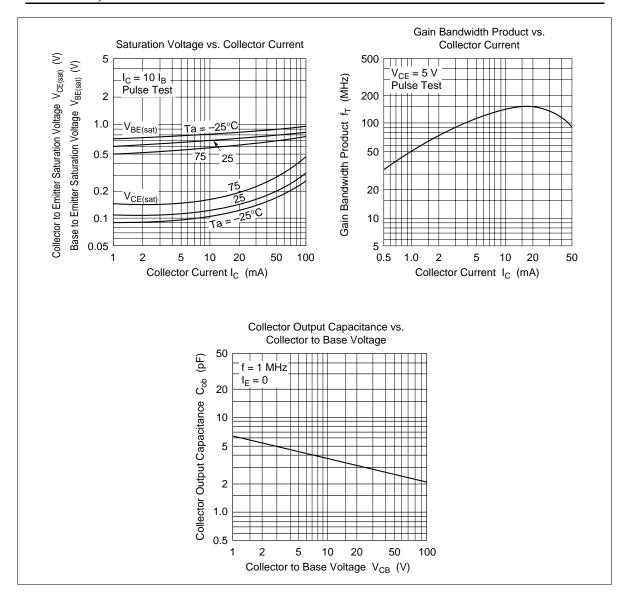
Grade	В	С	D
h _{FE1}	60 to 120	100 to 200	160 to 320



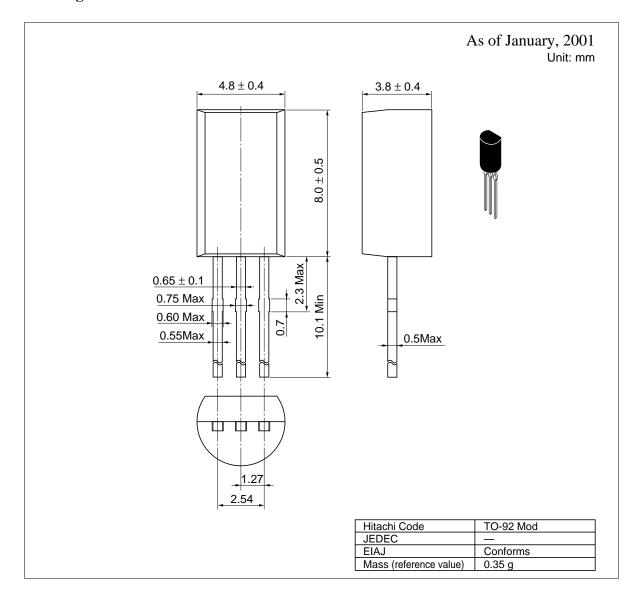








Package Dimensions



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